

INTERNATIONAL STANDARD

NORME INTERNATIONALE



**Field Device Integration (FDI) –
Part 3: FDI Server**

**Intégration des appareils de terrain (FDI) –
Partie 3: Serveur FDI**



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**Field Device Integration (FDI) –
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FIELD DEVICE INTEGRATION (FDI) –

Part 3: FDI Server

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The text of this standard is based on the following documents:

CDV	Report on voting
65E/346/CDV	65E/423/RVC

Full information on the voting for the approval of this standard can be found in the report on voting indicated in the above table.

This publication has been drafted in accordance with the ISO/IEC Directives, Part 2.

A list of all parts in the IEC 62769 series, published under the general title *Field Device Integration (FDI)*, can be found on the IEC website.

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FIELD DEVICE INTEGRATION (FDI) – Part 3: FDI Server

1 Scope

This part of IEC 62769 specifies the FDI Server. The overall FDI architecture is illustrated in Figure 1. The architectural components that are within the scope of this document have been highlighted in this figure.

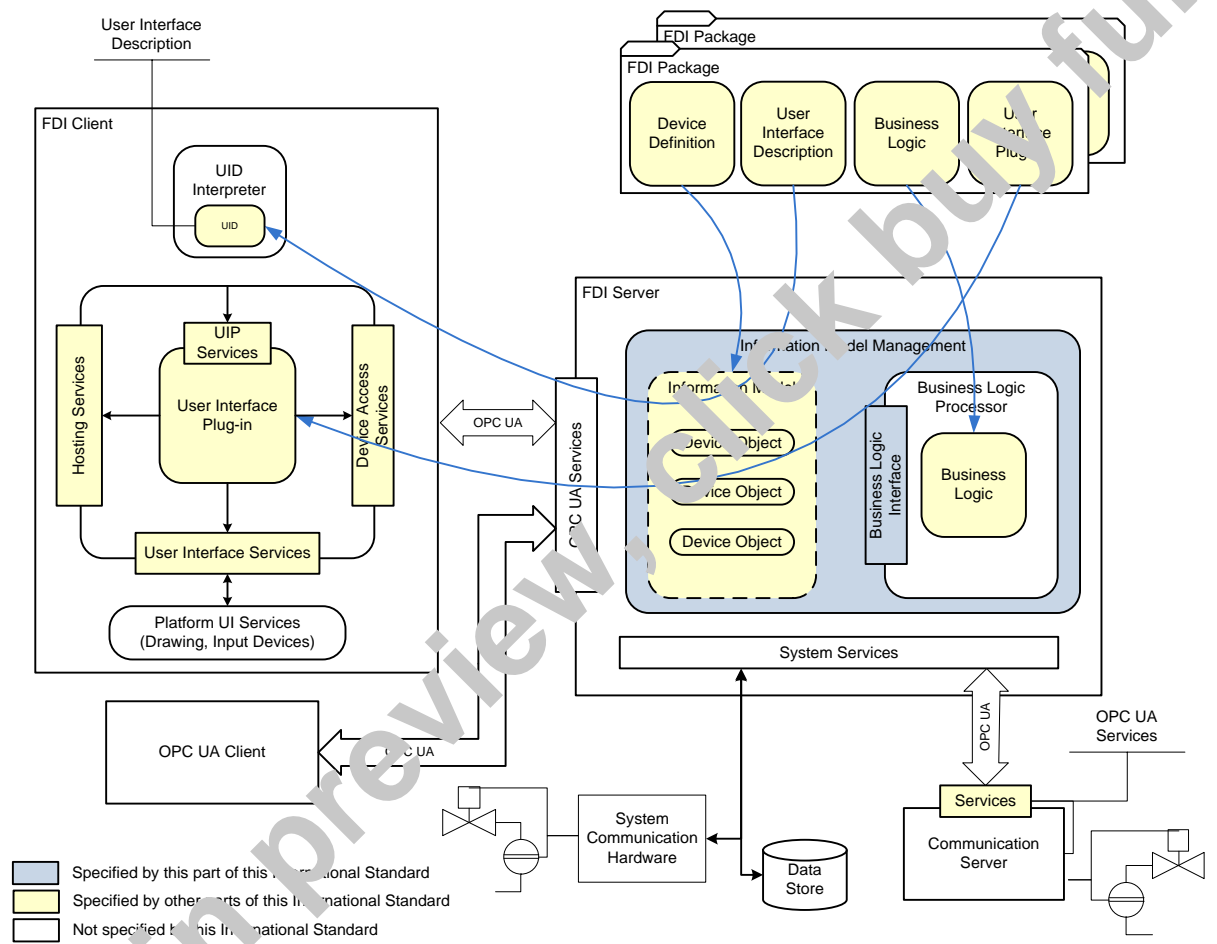


Figure 1 – FDI architecture diagram

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IEC 61804 (all parts), *Function blocks (FB) for process control and Electronic Device Description Language (EDDL)*